

ECAL Electronics  
Radiation Damage Studies:  
Comparing Two Accelerators  
PSI and FSU

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Oct. 29, 2009

# Radiation Studies – ECAL Electronics

- Want to test radiation damage effects on ECAL electronics boards
- Use low energy (15-25 MeV) proton beam
- Desired exposure >500 Gy (see backup slides for calculations)
- This equals  $>6.4 \times 10^{11}$  protons delivered
- Two sites under consideration
  - Paul Scherrer Institute (PSI)
    - Large user facility
  - Florida State University (FSU)
    - Smaller, nuclear (light ion) accelerator

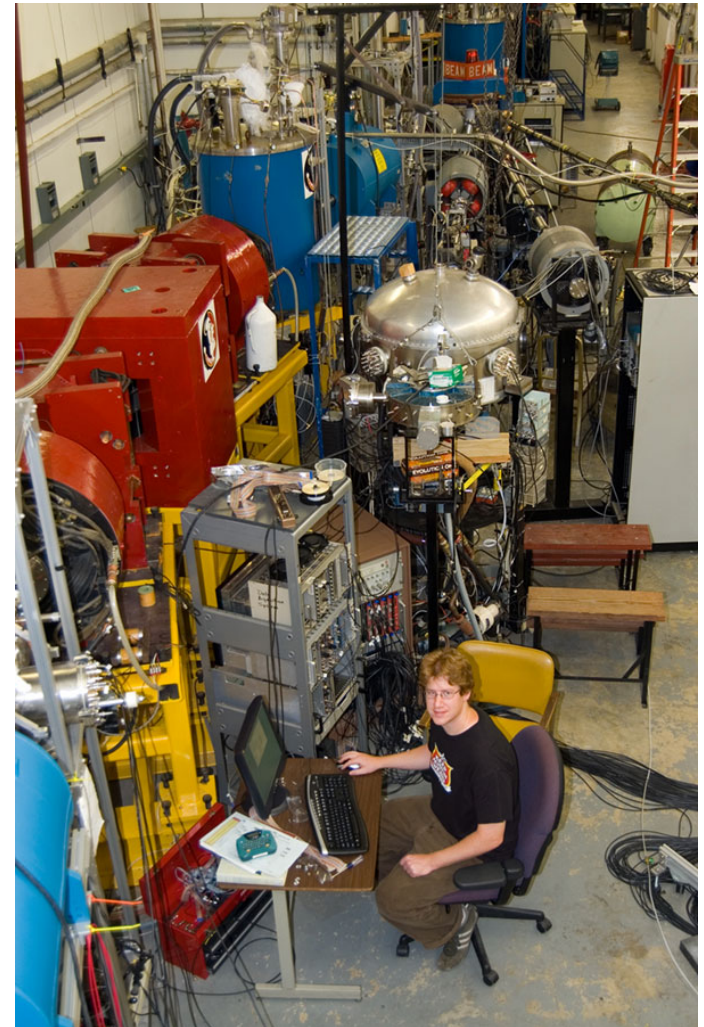
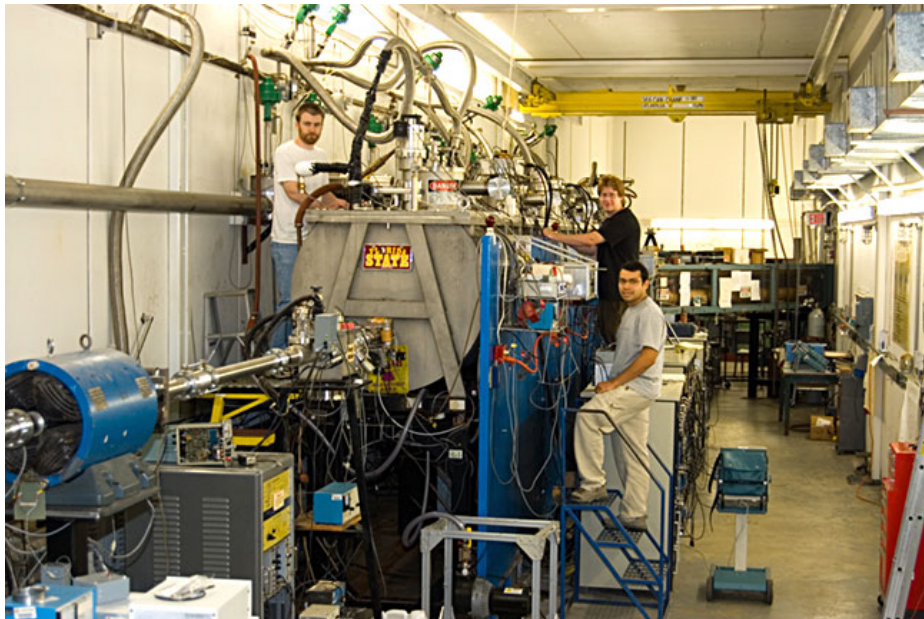
# Comparison of PSI versus FSU

	PSI	FSU
Beam Energy	25 MeV	18 MeV
Beam Intensity	5x10 <sup>8</sup> /cm <sup>2</sup> /s 3.4x10 <sup>15</sup> protons/day	1.5x10 <sup>12</sup> /cm <sup>2</sup> /s 10 <sup>17</sup> protons/day
Beam size	5 cm diameter	5 mm diameter
Running time	Beam size >> chip size 6.4x10 <sup>11</sup> protons/(5x10 <sup>8</sup> protons/ cm <sup>2</sup> /s * 0.194 cm <sup>2</sup> ) = <b>6600 s</b>	Beam size ~ chip size 6.4x10 <sup>11</sup> protons/1x10 <sup>17</sup> protons/ day = 6.4x10 <sup>-7</sup> days = <b>0.56 s</b>

- FSU beam spot is approximately chip size, PSI much bigger
- FSU can be defocused for larger beam spot and intensity turned down for longer running period
  - Slightly higher beam energy may be possible
- FSU beam time is free

# FSU Nuclear Accelerator

- On campus nuclear accelerator
  - Tandem + Linac
  - Primarily light ions
- Mostly local users + friends
  - Not a traditional user facility



# Back-up Slides

# Inputs

- Chip size: 0.2" x 0.15" x 0.025"
- Surface area
  - 0.2" x 0.15" = 0.03 sq in = 0.194 cm<sup>2</sup>
- Amount of silicon
  - 0.194 cm<sup>2</sup> x 0.0635 cm x 2.33 g/cm<sup>3</sup> = 0.029 gm
- Position of electronics
  - 1.7 m from beam

# Inputs (cont.)

- Assuming  $dE/dx = 20$  MeV cm<sup>2</sup>/g for protons in silicon
  - $20 \text{ MeV cm}^2/\text{g} * 2.33 \text{ g/cm}^3 = 2.2 \text{ MeV/cm}$  per proton
- Multiplying by the thickness
  - $2.2 \text{ MeV/cm} * 0.064 \text{ cm} = 0.141 \text{ MeV}$  per proton

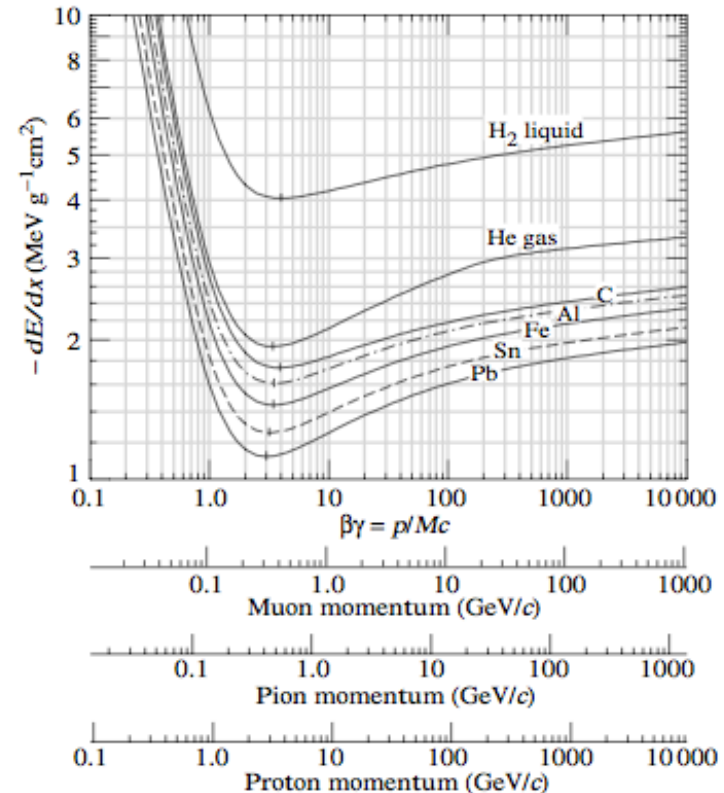


Figure 27.3: Mean energy loss rate in liquid (bubble chamber) hydrogen, gaseous helium, carbon, aluminum, iron, tin, and lead. Radiative effects, relevant for muons and pions, are not included. These become significant for muons in iron for  $\beta\gamma \gtrsim 1000$ , and at lower momenta for muons in higher-Z absorbers. See Fig. 27.21.

# Radiation Requirements

- $1 \text{ Gy} = 6.24 \times 10^{12} \text{ MeV/kg}$
- $500 \text{ Gy} * 6.24 \times 10^{12} \text{ MeV/kg} * 2.9 \times 10^{-5} \text{ kg} = 9 \times 10^{10} \text{ MeV}$
- $9 \times 10^{10} \text{ MeV} / 0.141 \text{ MeV/proton} = 6.4 \times 10^{11}$  protons
- So we need to deliver  $6.4 \times 10^{11}$  protons to the chip to cause 500 Gy